## PLAP1 (Logitech Lapping/Polishing System)

T4		m ·	- Tr. •	<u> </u>
Item No.	Item Description	Trainer Initial	Trainee Initial	Date
1.0	Know location of operating procedure and manual.			
2.0	Identify components of the instrument including Polishing Plates, Sample Fixture, Arm, Glass Mounting Substrates, Abrasive AlOxide Containers, Plate Polishing Fixture, Mounting Wax, Vacuum Pump, Waste Container.			
3.0	Understand safety aspects (Hotplate, Vacuum Pump, Polishing Wheel).			
4.0	Demonstrate ability to load samples onto glass substrates, into the fixture, and onto the polishing wheel.			
5.0	Understand the Vacuum Pump Shut Down Sequence.			
6.0	Demonstrate operation of the Joystick Functions, Plate, Abrasive, Arm parameters.			
Certifi	cation completed:			
Signature of trainee			Date	

Signature of trainer

Date